

FIG. 2

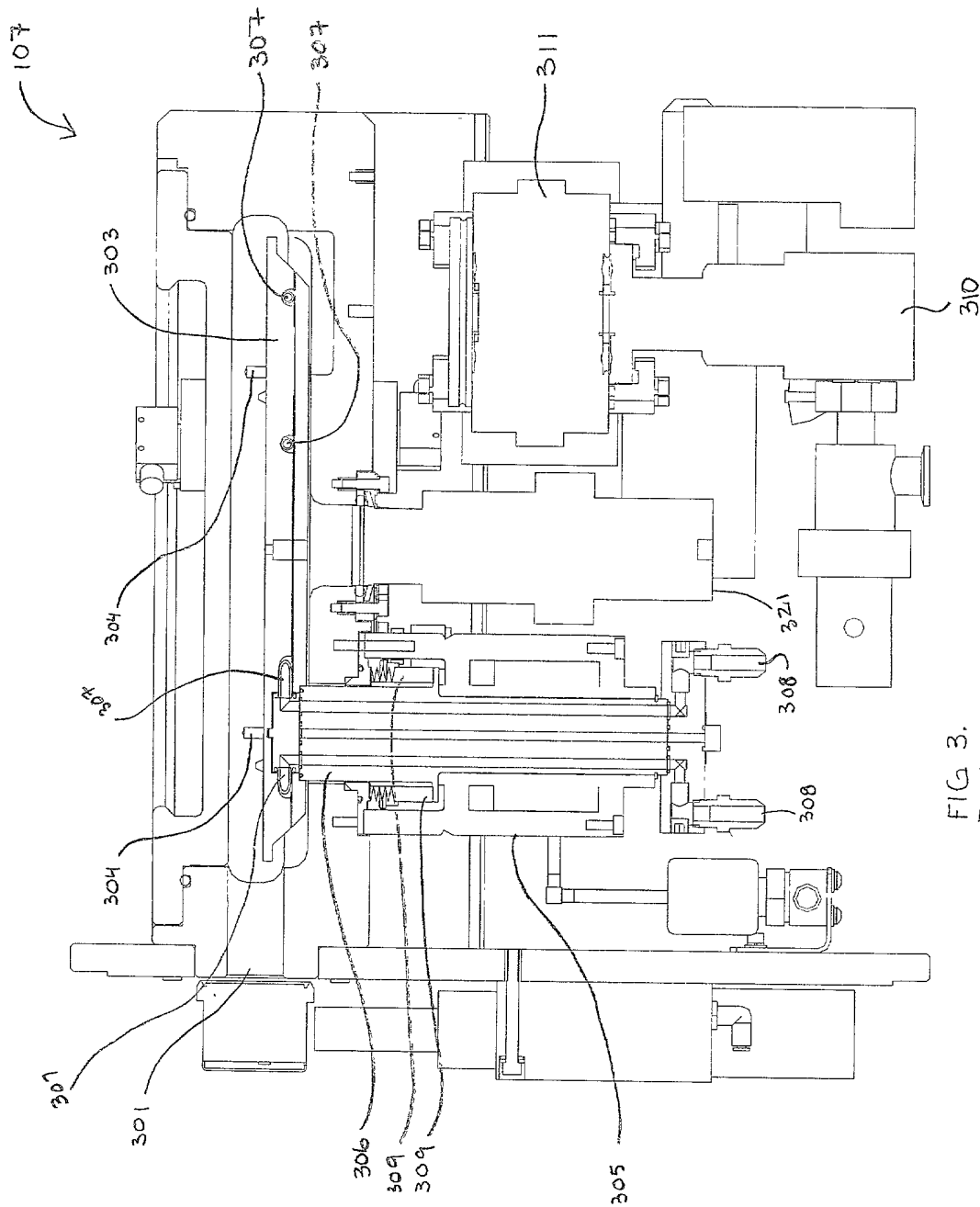


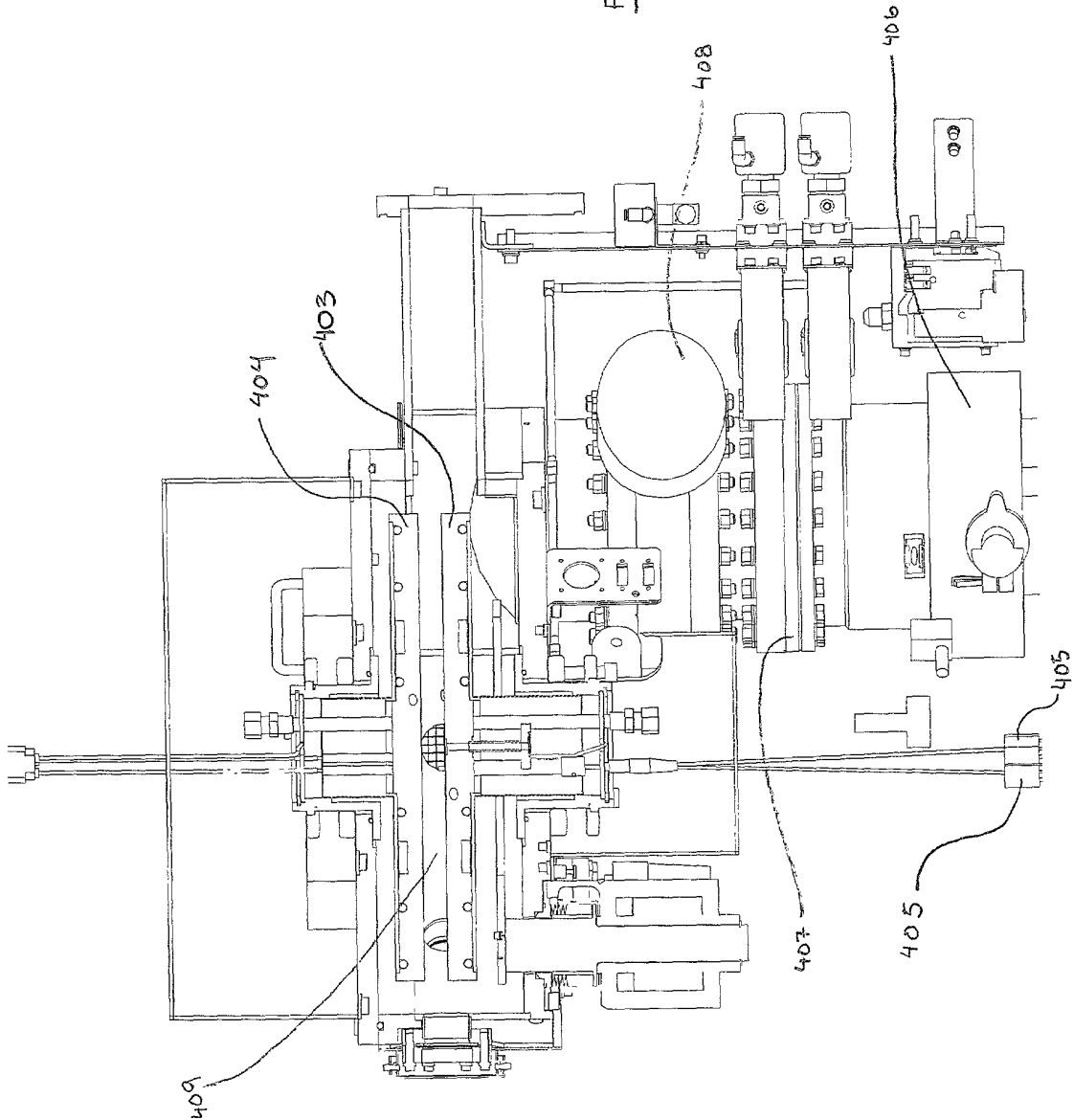
FIG. 3.

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FIG. 4



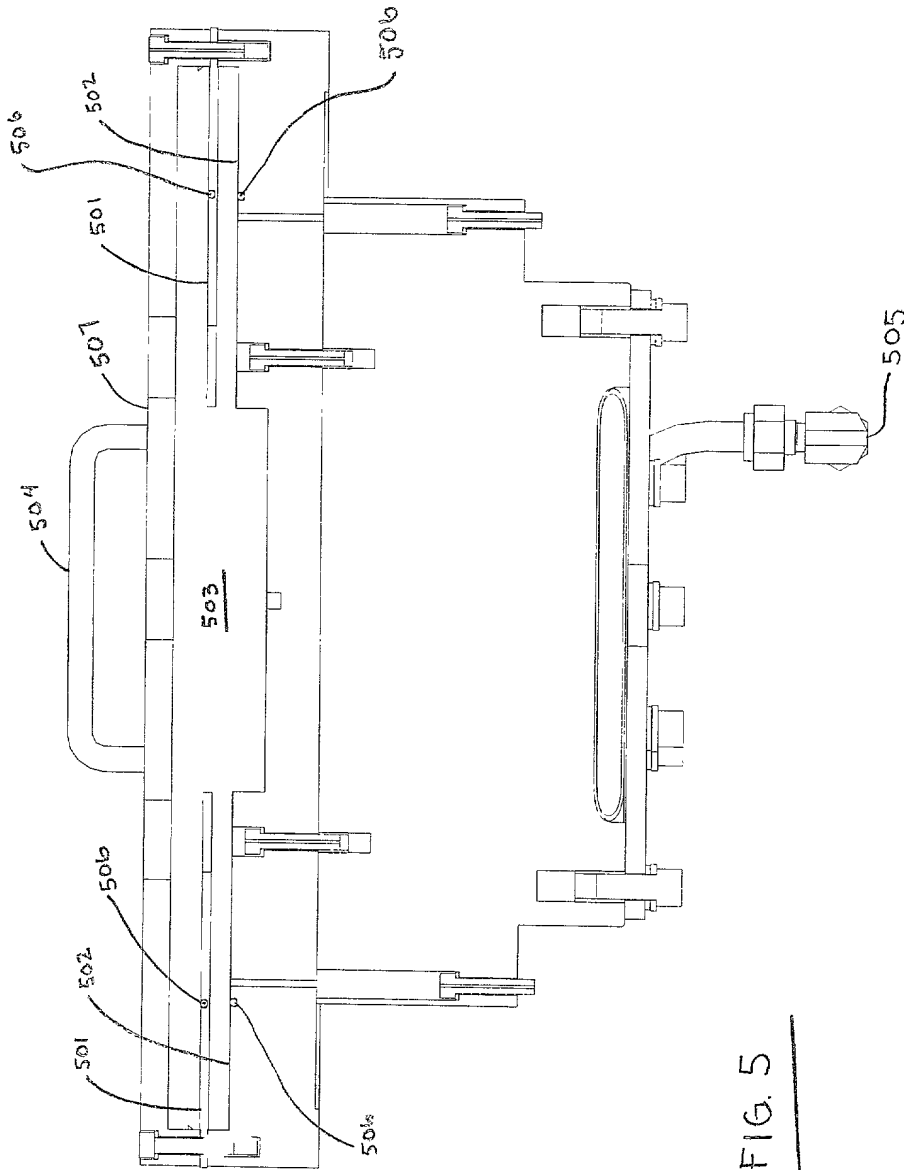


FIG. 5

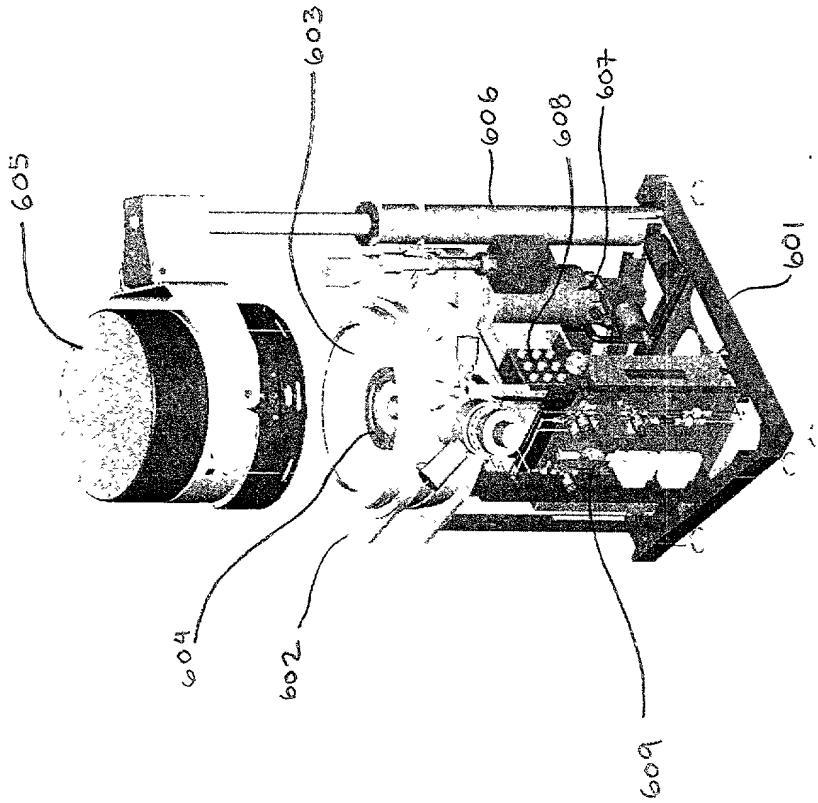


FIG. 6

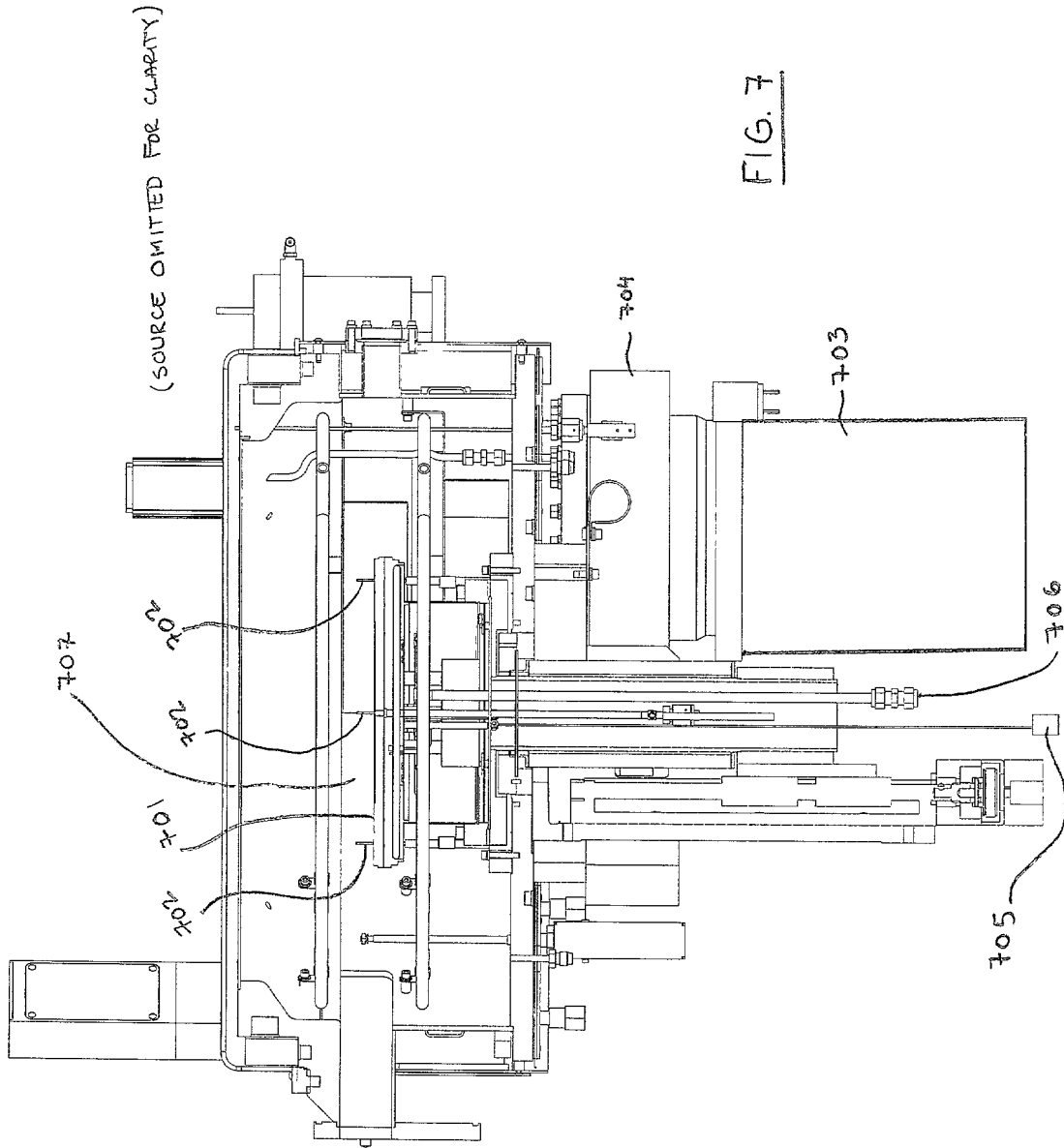
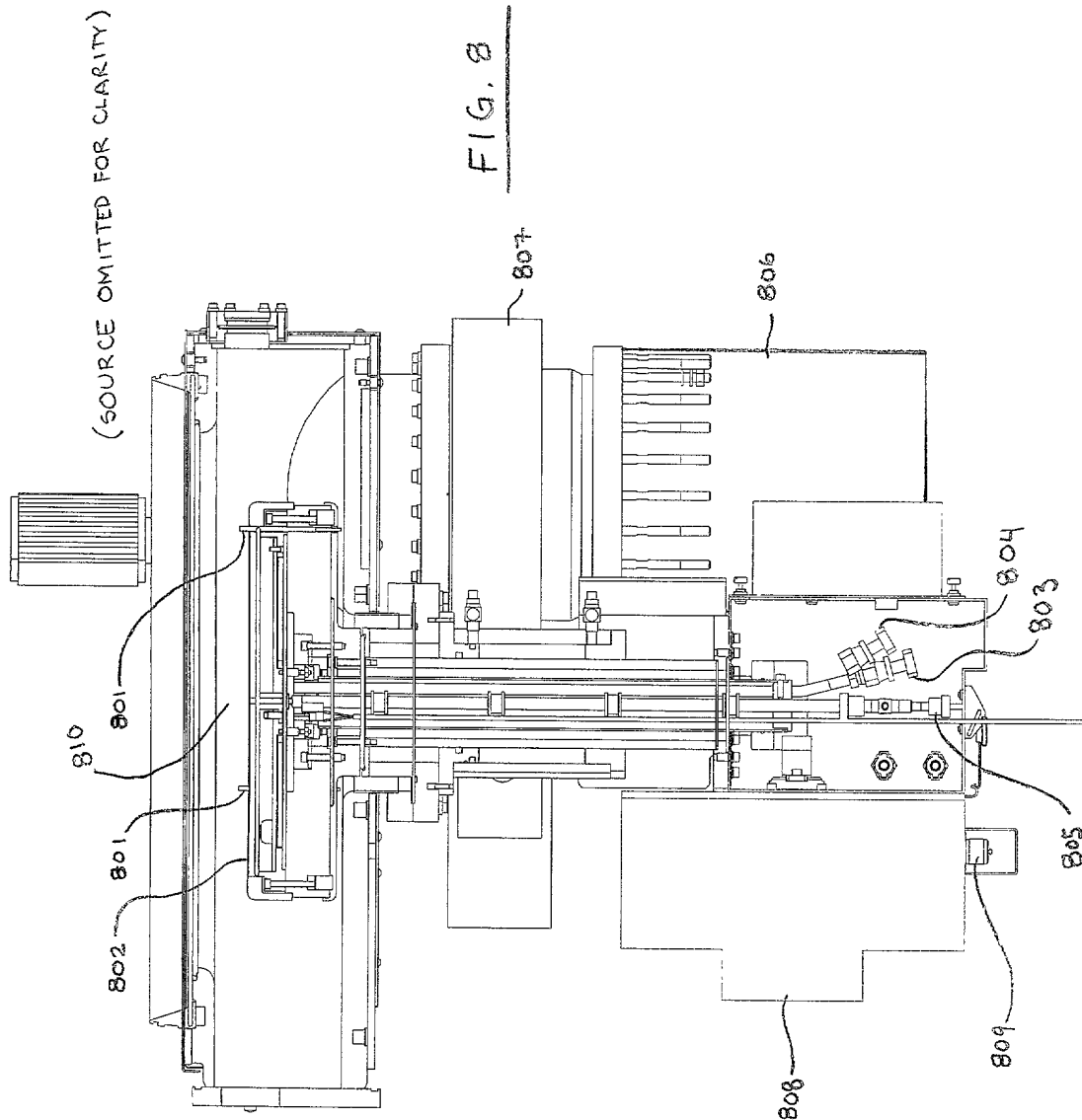


FIG. 7



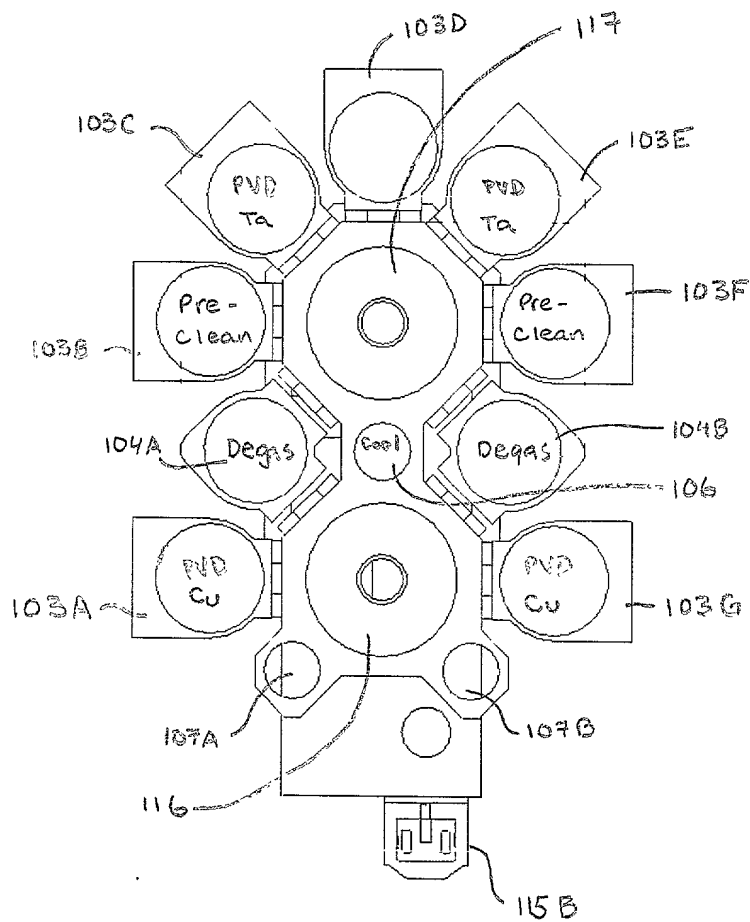


FIG. 9A

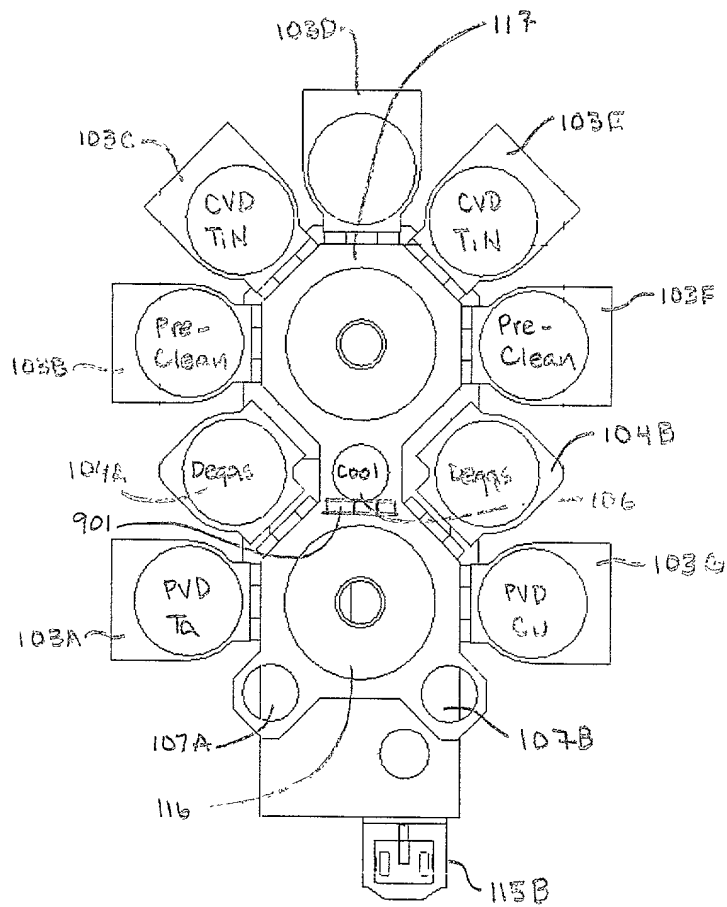


FIG. 9B

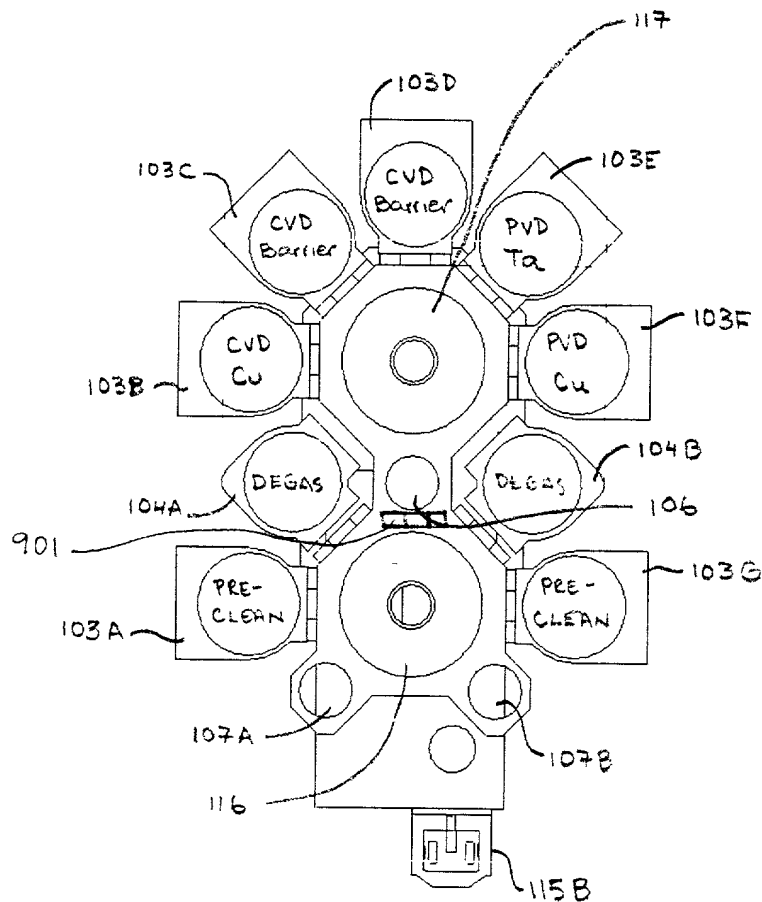


FIG. 9C

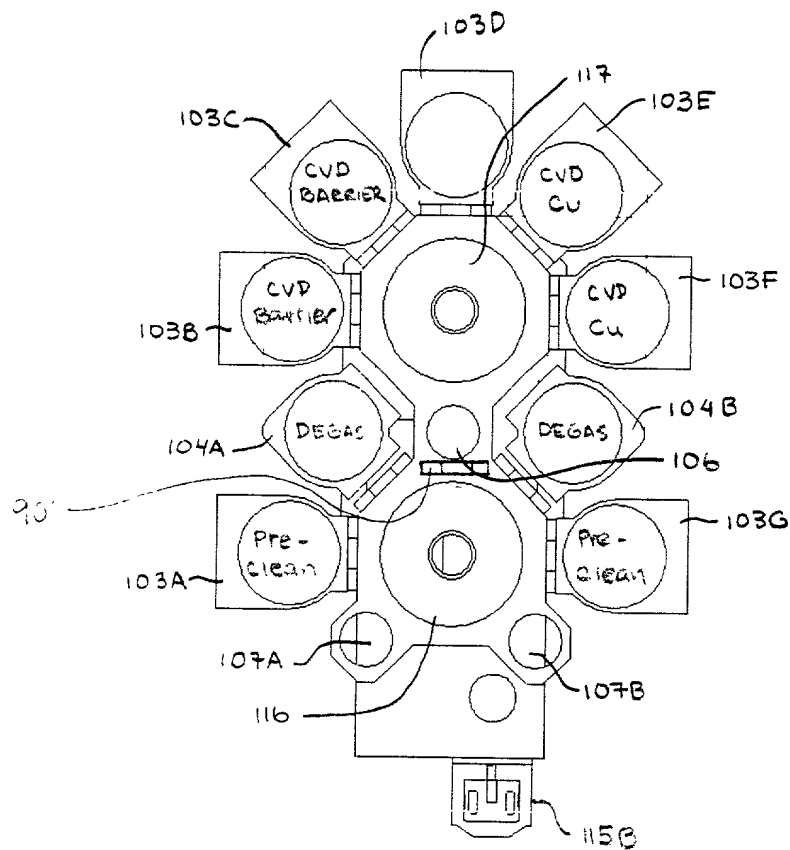


FIG. 9D

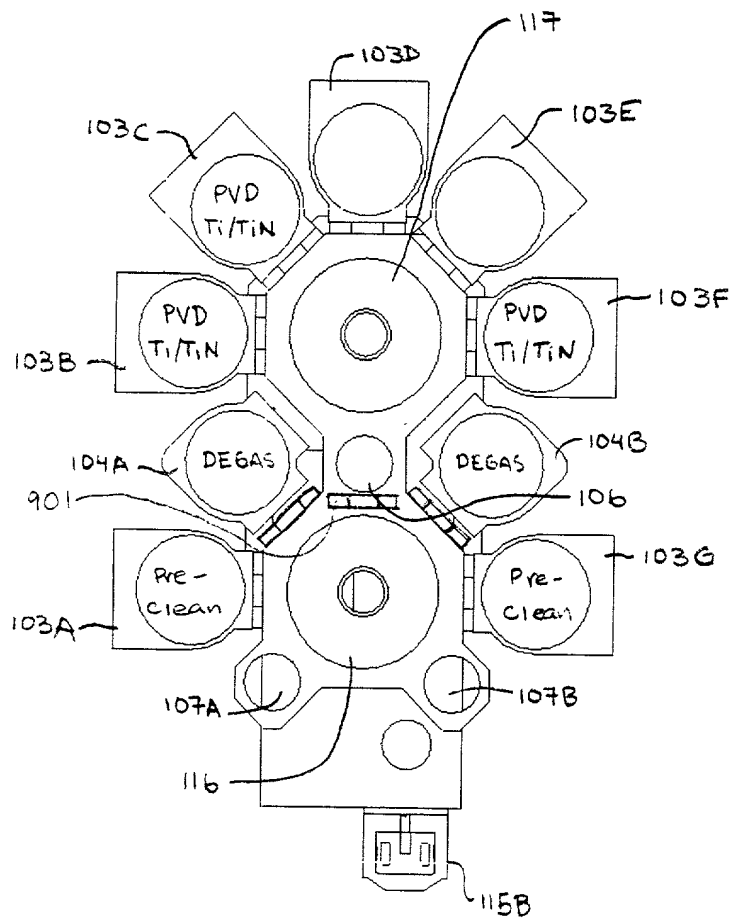


FIG. 10A

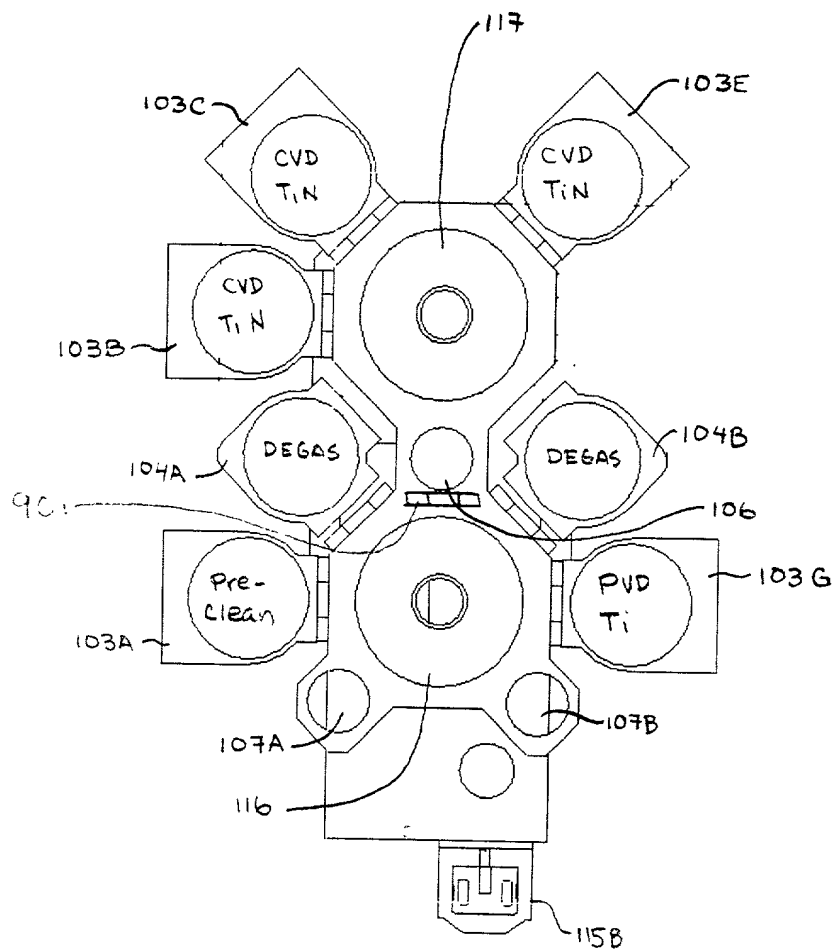


FIG. 10B